

## **Dual N-Channel 100-V (D-S) MOSFET**

PRODUCT SUMMARY						
V <sub>DS</sub> (V)	$R_{DS(on)}\left(\Omega\right)$	I <sub>D</sub> (A) <sup>d</sup>	Q <sub>g</sub> (Typ.)			
100	0.063 at V <sub>GS</sub> = 10 V	5.8	9 nC			
100	0.084 at V <sub>GS</sub> = 6 V	4.8	9110			

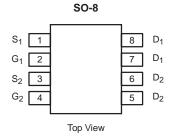
#### **FEATURES**

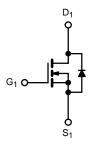
- Halogen-free According to IEC 61249-2-21 Available
- Trench Power MOSFET
- 100 % UIS Tested

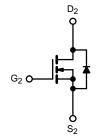
# ROHS COMPLIANT HALOGEN

#### **APPLICATIONS**

- High Frequency Boost Converter
- LED Backlight for LCD TV







N-Channel MOSFET

N-Channel MOSFET

Parameter	Symbol	Limit	Unit		
Drain-Source Voltage	V <sub>DS</sub>	100	V		
Gate-Source Voltage		$V_{GS}$		± 20	
	T <sub>C</sub> = 25 °C		5.8		
Continuous Drain Current (T = 150 °C)	T <sub>C</sub> = 70 °C		4.4		
Continuous Drain Current (T <sub>J</sub> = 150 °C)	T <sub>A</sub> = 25 °C	I <sub>D</sub>	3.4 <sup>a, b</sup>		
	T <sub>A</sub> = 70 °C		2.5 <sup>a, b</sup>	^	
Pulsed Drain Current	I <sub>DM</sub>	20	A		
Ocaliana Ocama Davia Dia la Ocama	T <sub>C</sub> = 25 °C T <sub>A</sub> = 25 °C	I.	5		
Continuous Source-Drain Diode Current		I <sub>S</sub>	2.1 <sup>a, b</sup>		
Single Avalanche Current	L = 0.1 mH	I <sub>AS</sub>	19		
Single Avalanche Energy	L = U.1 IIII	E <sub>AS</sub>	18	mJ	
	T <sub>C</sub> = 25 °C		5		
Manine Danier Dissipation	T <sub>C</sub> = 70 °C		3.2	w	
Maximum Power Dissipation	T <sub>A</sub> = 25 °C	P <sub>D</sub>	2.5 <sup>a, b</sup>	VV	
	T <sub>A</sub> = 70 °C		1.6 <sup>a, b</sup>		
Operating Junction and Storage Temperature	T <sub>J</sub> , T <sub>stg</sub>	- 55 to 150	°C		

THERMAL RESISTANCE RATINGS							
Parameter	Symbol	Typical	Maximum	Unit			
Maximum Junction-to-Ambient <sup>b, c</sup>	t ≤ 10 s	$R_{thJA}$	37	50	°C/W		
Maximum Junction-to-Foot (Drain)	Steady State	$R_{thJF}$	17	21	0/ **		

#### Notes

- a. Surface Mounted on 1" x 1" FR4 board.
- b. t = 10 s.
- c. Maximum under Steady State conditions is 85 °C/W.
- d.  $T_C = 25$  °C.

服务热线:400-655-8788

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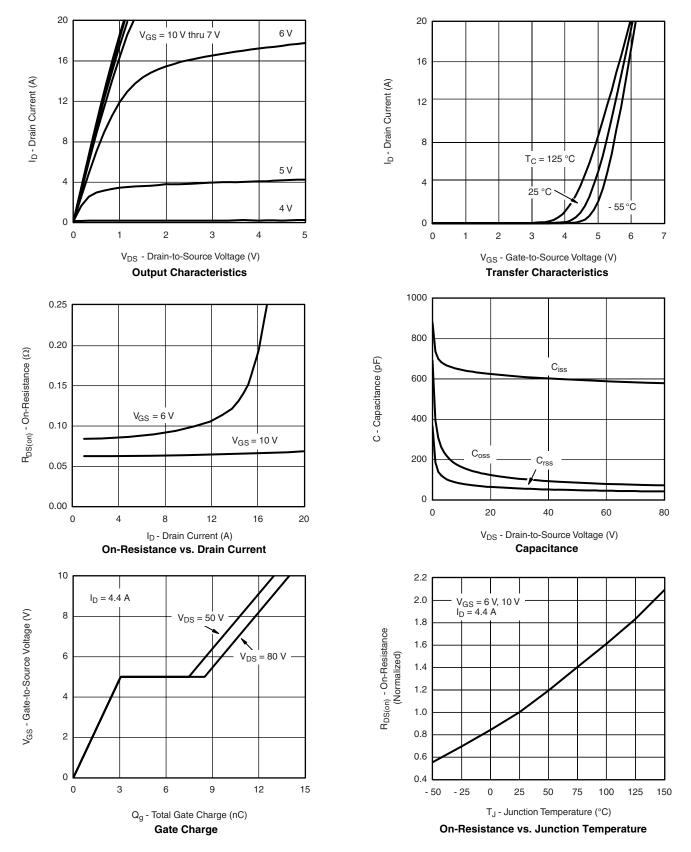
SPECIFICATIONS T <sub>J</sub> = 25 °C, unless otherwise noted							
Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static	1		I	T	ı		
Drain-Source Breakdown Voltage	V <sub>DS</sub>	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$	100			V	
V <sub>DS</sub> Temperature Coefficient	$\Delta V_{DS}/T_{J}$	I <sub>D</sub> = 250 μA		120		mV/°	
V <sub>GS(th)</sub> Temperature Coefficient	$\Delta V_{GS(th)}/T_J$			- 9			
Gate-Source Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}$ , $I_D = 250 \mu A$	2		4.5	V	
Gate-Source Leakage	I <sub>GSS</sub>	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$			± 100	nA	
Zero Gate Voltage Drain Current		$V_{DS} = 100 \text{ V}, V_{GS} = 0 \text{ V}$	1		1	μА	
Zero Gate Voltage Drain Current	IDSS	$V_{DS}$ = 100 V, $V_{GS}$ = 0 V, $T_J$ = 55 °C			10 F		
On-State Drain Current <sup>a</sup>	I <sub>D(on)</sub>	$V_{DS} \ge 5 \text{ V}, V_{GS} = 10 \text{ V}$	20			Α	
	_	$V_{GS} = 10 \text{ V}, I_D = 3.4 \text{ A}$		0.063			
Drain-Source On-State Resistance <sup>a</sup>	R <sub>DS(on)</sub>	$V_{GS} = 6 \text{ V}, I_D = 2.8 \text{ A}$		0.084		Ω	
Forward Transconductance <sup>a</sup>	9 <sub>fs</sub>	$V_{DS} = 15 \text{ V}, I_D = 3.4 \text{ A}$		10		S	
Dynamic <sup>b</sup>				ı			
Input Capacitance	C <sub>iss</sub>			600			
Output Capacitance	C <sub>oss</sub>	$V_{DS} = 50 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$		90		pF	
Reverse Transfer Capacitance	C <sub>rss</sub>			50			
		$V_{DS} = 50 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 3.4 \text{ A}$		13.5	20	nC	
Total Gate Charge	Q <sub>g</sub>			9	13.5		
Gate-Source Charge	$Q_{gs}$	$V_{DS} = 50 \text{ V}, V_{GS} = 6 \text{ V}, I_{D} = 3.4 \text{ A}$		3			
Gate-Drain Charge	Q <sub>gd</sub>			4.6			
Gate Resistance	R <sub>g</sub>	f = 1 MHz		1		Ω	
Turn-On Delay Time	t <sub>d(on)</sub>			15	25		
Rise Time	t <sub>r</sub>	$V_{DD} = 50 \text{ V}, R_{I} = 14.3 \Omega$		12	20	1	
Turn-Off Delay Time	t <sub>d(off)</sub>	$I_D \cong 3.5 \text{ A}, V_{GEN} = 6 \text{ V}, R_g = 1 \Omega$		12	20		
Fall Time	t <sub>f</sub>	· ·		10	15		
Turn-On Delay Time	t <sub>d(on)</sub>			10	15	ns	
Rise Time	t <sub>r</sub>	$V_{DD} = 50 \text{ V}, R_{L} = 14.3 \Omega$		12	20		
Turn-Off Delay Time	t <sub>d(off)</sub>	$I_D \cong 3.5 \text{ A}, V_{GEN} = 10 \text{ V}, R_q = 1 \Omega$		15	25		
Fall Time	t <sub>f</sub>	3		10	15	1	
Drain-Source Body Diode Characteristic	•						
Continuous Source-Drain Diode Current	Is	T <sub>C</sub> = 25 °C			5		
Pulse Diode Forward Current	I <sub>SM</sub>				20	Α	
Body Diode Voltage	V <sub>SD</sub>	I <sub>S</sub> = 3.5 A, V <sub>GS</sub> = 0 V		0.8	1.2	V	
Body Diode Reverse Recovery Time	t <sub>rr</sub>			45	70	ns	
Body Diode Reverse Recovery Charge	Q <sub>rr</sub>			80	120	nC	
Reverse Recovery Fall Time	t <sub>a</sub>	$I_F = 3.5 \text{ A}, \text{ dI/dt} = 100 \text{ A/}\mu\text{s}, T_J = 25 ^{\circ}\text{C}$		33	120	1.0	
Reverse Recovery Rise Time	t <sub>b</sub>	$\dashv$		12		ns	

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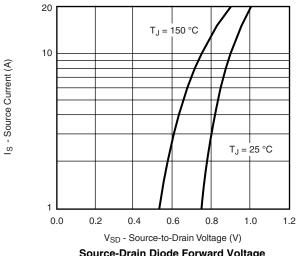
- a. Pulse test; pulse width  $\leq$  300  $\mu s,$  duty cycle  $\leq$  2 % b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

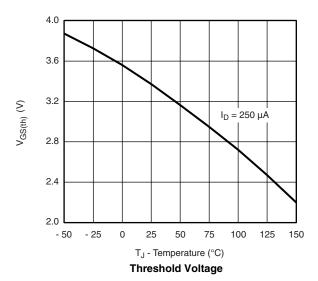


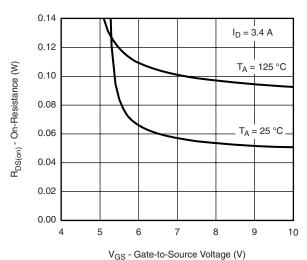




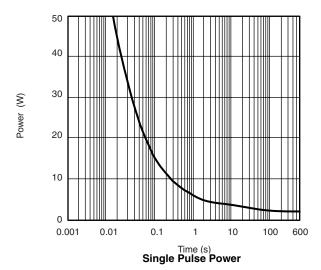


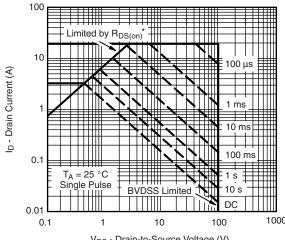
#### Source-Drain Diode Forward Voltage





On-Resistance vs. Gate-to-Source Voltage

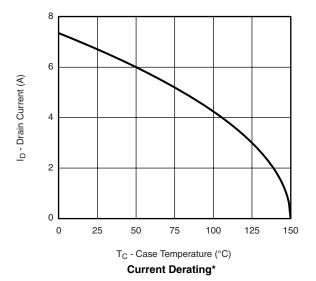


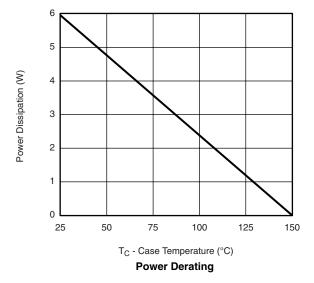


V<sub>DS</sub> - Drain-to-Source Voltage (V)  $^{\star}$   $V_{GS}$  > minimum  $V_{GS}$  at which  $R_{DS(on)}$  is specified

Safe Operating Area, Junction-to-Ambient

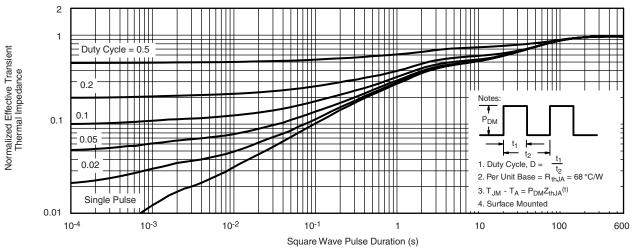




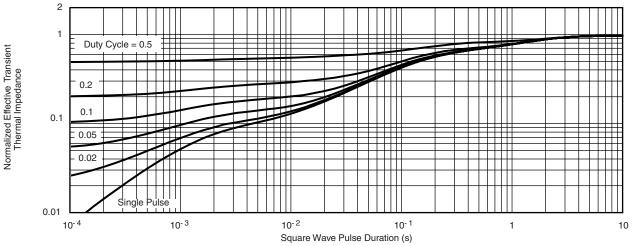


<sup>\*</sup> The power dissipation  $P_D$  is based on  $T_{J(max)} = 150$  °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.





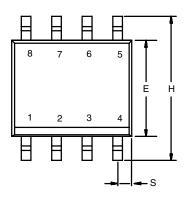
Normalized Thermal Transient Impedance, Junction-to-Ambient

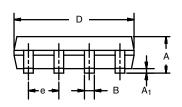


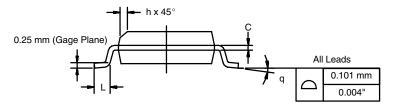
Normalized Thermal Transient Impedance, Junction-to-Foot



**SOIC (NARROW): 8-LEAD**JEDEC Part Number: MS-012







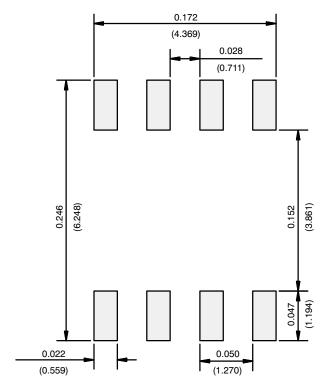
	MILLIM	IETERS	INC	INCHES		
DIM	Min	Max	Min	Max		
Α	1.35	1.75	0.053	0.069		
A <sub>1</sub>	0.10	0.20	0.004	0.008		
В	0.35	0.51	0.014	0.020		
С	0.19	0.25	0.0075	0.010		
D	4.80	5.00	0.189	0.196		
Е	3.80	4.00	0.150	0.157		
е	1.27	BSC	0.050	0.050 BSC		
Н	5.80	6.20	0.228	0.244		
h	0.25	0.50	0.010	0.020		
L	0.50	0.93	0.020	0.037		
q	0°	8°	0°	8°		
S	0.44	0.64	0.018	0.026		
ECN: C-06527-Rev. I, 11-Sep-06						

DWG: 5498

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### **RECOMMENDED MINIMUM PADS FOR SO-8**



Recommended Minimum Pads Dimensions in Inches/(mm)



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